



ZL50112GAG2 Information

Heisener.com

Part Number ZL50112GAG2

Manufacturer Microsemi Corporation

Category Integrated Circuits (ICs)
Interface - Telecom

Description IC CESOP PROCESSOR 552BGA

Package 552-BGA

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









ZL50112GAG2 Specifications

Manufacturer Part Number	ZL50112GAG2
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Interface - Telecom
Package	552-BGA
Series	-
Function	Telecom Circuit
Interface	TDM
Number of Circuits	1
Voltage - Supply	1.65 V ~ 1.95 V
Current - Supply	950mA
Power (Watts)	-
Operating Temperature	-40°C ~ 85°C
Mounting Type	Surface Mount
Package / Case	552-BGA
Supplier Device Package	552-PBGA (35x35)
	Report errors?

ZL50112GAG2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

ZL50112GAG2 Payment Methods



















ZL50112GAG2 Shipping Methods













If you have any question about ZL50112GAG2, please do not hesitate to contact us!

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